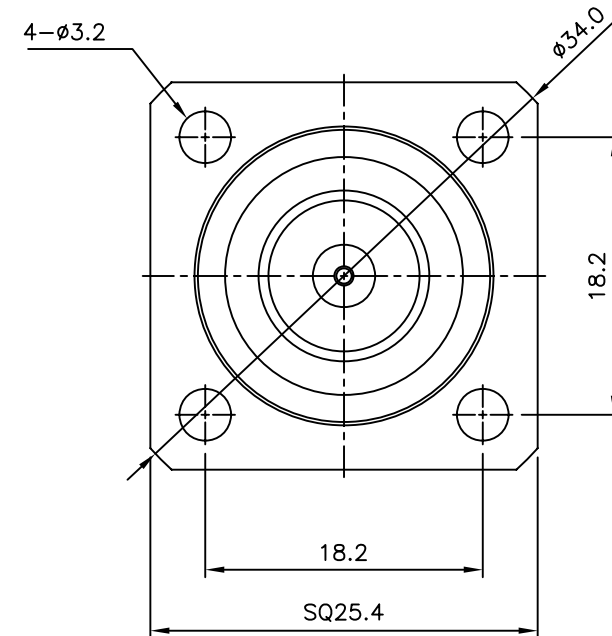
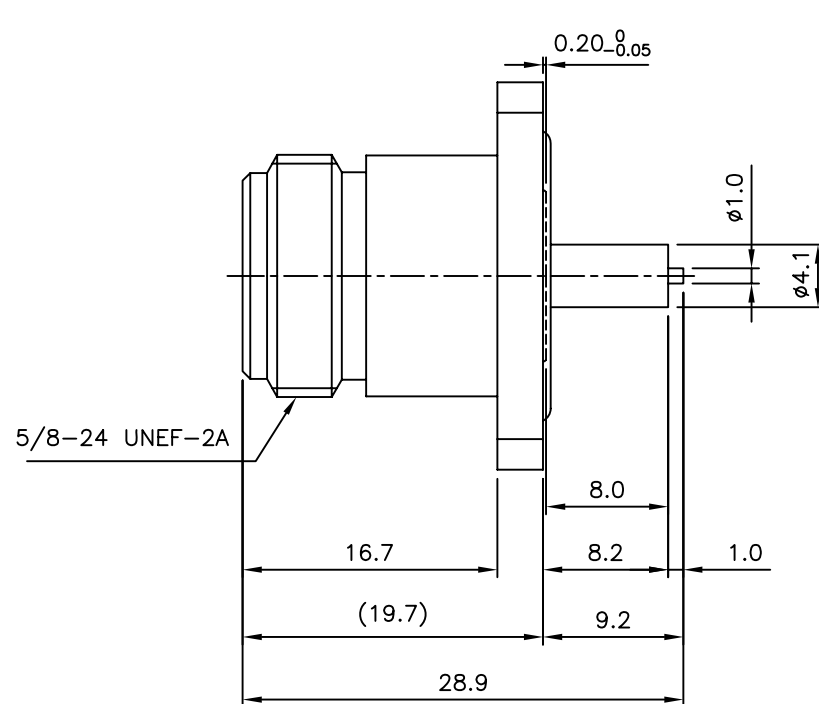


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2020.03.05.
1	조립공차변경 ±0.1 -> ±0.2	S.Y.EUN	I.C.KIM	2021.01.22.



4	INSULATOR	1	TEFLON		DIN03127-N/1
3	GASKET	1	Silicone Rub		DGK00045-N/1
2	CONTACT	1	BeCu C17300	Silver Plate (3μm)	DCT04110-5/1
1	BODY	1	MBsBD C3604BD-F	SUCO Plate (3μm)	DBD03606-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal  ±0.2	DATE 2021. 01. 22.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017			
	Angle ±1°	APPROVED BY	I.C.KIM					
MATERIAL		CHECKED BY	TITLE N50 SOLDER END JS-4H					
		DRAWN BY				S.Y.EUN		
FINISH		SCALE 2/1	UNIT mm		A4	DWG NO.	CN03913-7/1	
						REVISION	1	SHEET